

SSC8048GT8

N-Channel Enhancement Mode MOSFET

> Features

V _{DS}	V _{GS}	R _{DS(ON)} Typ.	ID
40V	1 201/	6.6mΩ@10V	604
	±20V	8.2mΩ@4V5	60A

Description

This device is N-Channel enhancement MOSFET.

Uses advanced trench technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit.

100% UIS + ΔVDS + Rg Tested!

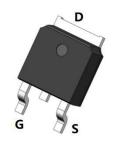
Applications

- Motor Drive Control
- Portable Devices
- DCDC Conversion
- Power Supplies
- Synchronous Rectification

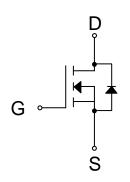
Ordering Information

Device	Package	Shipping
SSC8048GT8	TO-252-2L	2500/Reel

Pin Configuration



TO-252-2L (Top View)



Pin Configuration



Marking

(XXYY: Internal Traceability Code)



➤ Absolute Maximum Ratings (T_A=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit		
V _{DSS}	Drain-to-Source Voltage		40	V	
V _{GSS}	Gate-to-Source Volta	ge	±20	V	
		60	^		
l _D	Continuous Drain Current	T _C =100℃	35	1 A	
	Outine Dair Out 1	$Gate-to-Source Voltage$ $Dus Drain Current ^d \qquad T_C=25^{\circ}C$ $T_C=100^{\circ}C$ $T_A=25^{\circ}C$ $T_A=70^{\circ}C$ $Pulsed Drain Current ^b$ $T_C=100^{\circ}C$ $T_C=100^{\circ}C$ $T_A=25^{\circ}C$ $T_C=100^{\circ}C$ $T_A=70^{\circ}C$	18		
IDSM	Continuous Drain Current ^a	T _A =70°C	13	- A	
Ірм	Pulsed Drain Curren	t ^b	240	Α	
5	Barray Biratina 6	Tc=25℃	62.5	10/	
P_D	Power Dissipation •	Power Dissipation $^{\circ}$ Ta=70 $^{\circ}$ Power Dissipation $^{\circ}$ Tc=25 $^{\circ}$ Tc=100 $^{\circ}$ Ta=25 $^{\circ}$	25	W	
-	Barrer Birelinetine 6	Power Dissipation $^{\circ}$ Power Dissipation $^{\circ}$ Power Dissipation $^{\circ}$ Ta=70 $^{\circ}$ C Tc=25 $^{\circ}$ C Tc=100 $^{\circ}$ C Ta=25 $^{\circ}$ C	4.2	10/	
P _{DSM}	Power Dissipation ^a	T _A =70°C	2.7	W	
las	Avalanche Energy ^b L=0.5mH Single Pulse		20	Α	
Eas	Avalanche Energy ^b L=0.5mH Single Pulse		100	mJ	
TJ	Operation junction temperature		-55~150	°C	
T _{STG}	Storage temperature ra	ange	-55~150	$^{\circ}$	

➤ Thermal Resistance Ratings (T_A=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
RθJA	Junction-to-Ambient Thermal Resistance ^a	30	°C/W
R _{θJC}	Junction-to-Case Thermal Resistance	2	C/VV

Note:

- a. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with T_A=25°C. The value in any given application depends on the user is specific board design. The power dissipation is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on $T_{J(MAX)}$ =150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.

SSC-V1.0 www.sscsemi.com Analog Future



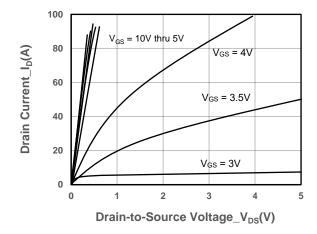


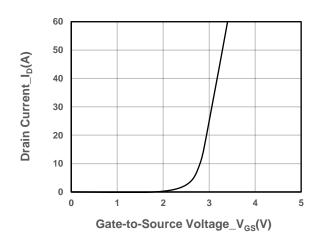
\succ Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250µA	40			V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250uA$	1	1.5	2.5	V
Drain-Source On-Resistance	D	V _{GS} = 10V, I _D = 30A		6.6	8.5	0
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 4.5V, I _D = 20A		8.2	10.6	mΩ
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 40V, V _{GS} = 0V			1	μA
Gate-Source Leak Current	Igss	V _{GS} = ±20V, V _{DS} = 0V			±100	nA
Forward Voltage	V _{SD}	V _{GS} = 0V, I _S = 20A			1.3	V
Input Capacitance	Cıss	V 00V V 0V		2400		
Output Capacitance	Coss	$V_{DS} = 20V$, $V_{GS} = 0V$, $f = 1MHz$		160		pF
Reverse Transfer Capacitance	Crss	I – IIVIDZ		146		
Total Gate Charge	Q_{G}	V - 40V V - 20V		47		
Gate to Source Charge	Q _{GS}	V _{GS} = 10V, V _{DS} = 20V,		9		nC
Gate to Drain Charge	Q _{GD}	I _D = 20A		10		
Turn-on Delay Time	T _{D(ON)}			10		
Rise Time	Tr	V _{GS} = 10V, V _{DS} = 20V,		26]
Turn-off Delay Time	$T_{D(OFF)}$	$I_D = 20A, R_G = 3\Omega$		39		ns
Fall Time	Tf			7		
Diode Recovery Time	Trr	I _F =20A, di/dt=100A/us		11		ns
Diode Recovery Charge	Qrr	I⊧=20A, di/dt=100A/us		4		nC



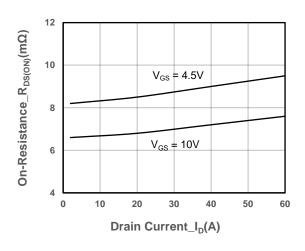
➤ Typical Performance Characteristics (T_A=25°C unless otherwise noted)

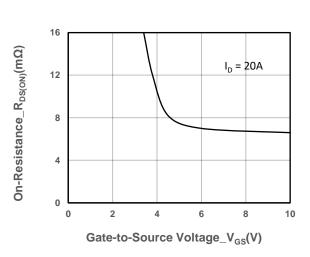




Output Characteristics

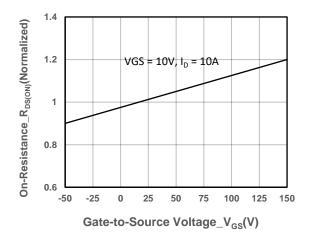
Transfer Characteristics

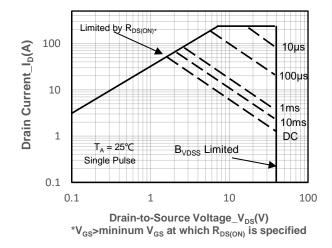




On-Resistance vs. Drain Current and Gate Voltag

On-Resistance vs. Gate-to-Source Voltage



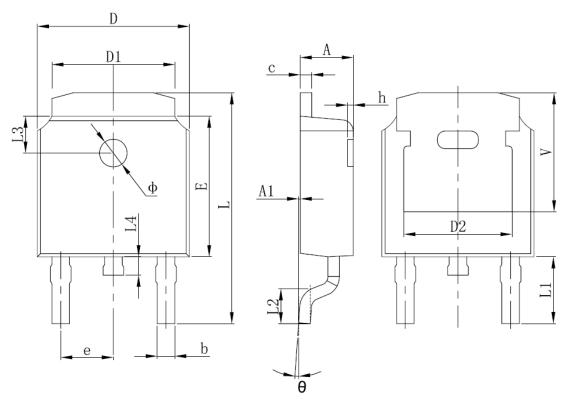


On-Resistance vs. Junction Temperature

Safe Operating Area vs. Junction-to-Ambient



Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.635	0.770	0.025	0.030	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.830	4.830 REF.		REF.	
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.712	10.312	0.382	0.406	
L1	2.900	REF. 0.114 REF.		REF.	
L2	1.400	1.700	0.055	0.067	
L3	1.600 REF.		0.063 REF.		
L4	0.600	1.000	0.024	0.039	
Φ	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.250 REF.		0.207 REF.		



DISCLAIMER

SSCSEMI RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. SSCSEMI DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICIENCE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

THE GRAPHS PROVIDED IN THIS DOCUMENT ARE STATISTICAL SUMMARIES BASED ON A LIMITED NUMBER OF SAMPLES AND ARE PROVIDED FOR INFORMATIONAL PURPOSE ONLY. THE PERFORMANCE CHARACTERISTICS LISTED IN THEM ARE NOT TESTED OR GUARANTEED. IN SOME GRAPHS, THE DATA PRESENTED MAY BE OUTSIDE THE SPECIFIED OPERATING RANGE (E.G. OUTSIDE SPECIFIED POWER SUPPLY RANGE) AND THEREFORE OUTSIDE THE WARRANTED RANGE.

OUR PRODUCT SPECIFICATIONS ARE ONLY VALID IF OBTAINED THROUGH THE COMPANY'S OFFICIAL WEBSITE, CRM SYSTEM, OR OUR SALES PERSONNEL CHANNELS. IF CHANGES OR SPECIAL VERSIONS ARE INVOLVED, THEY MUST BE STAMPED WITH A QUALITY SEAL AND MARKED WITH A SPECIAL VERSION NUMBER TO BE VALID.